To our customers,

Old Company Name in Catalogs and Other Documents

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Renesas Electronics website: http://www.renesas.com

April 1st, 2010
Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (http://www.renesas.com)

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RENESAS

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DATA SHEET

RENESAS

MOS FIELD EFFECT TRANSISTORS
2SK2499, 2SK2499-Z

SWITCHING
N-CHANNEL POWER MOS FET
INDUSTRIAL USE

DESCRIPTION

The 2SK2499 is N-Channel MOS Field Effect Transistor designed for high current switching applications.

FEATURES

- Low On-Resistance
  $R_{DS(on)1}$ = 9 mΩ (V_{GS} = 10 V, I_D = 25 A)
  $R_{DS(on)2}$ = 14 mΩ (V_{GS} = 4 V, I_D = 25 A)
- Low C_{iss} C_{iss} = 3 400 pF TYP.
- High Avalanche Capability.
- Built-in G-S Protection Diode

ABSOLUTE MAXIMUM RATINGS (T_A = 25 ˚C)

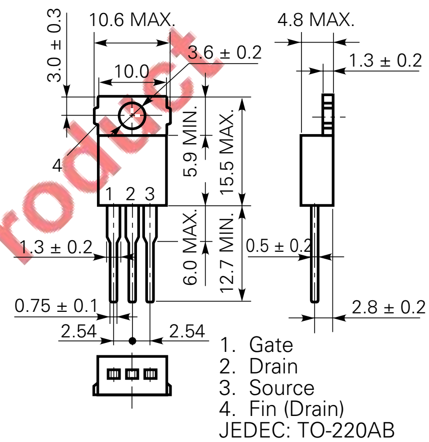
Drain to Source Voltage	V_{DSS}	60	V
Gate to Source Voltage	V_{GSS}	±20	V
Drain Current (DC)	$I_{D(DC)}$	±50	A
Drain Current (pulse)*	$I_{D(pulse)}$	±200	A
Total Power Dissipation (T_c = 25 ˚C)	P_{T1}	75	W
Total Power Dissipation (T_A = 25 ˚C)	P_{T2}	1.5	W
Channel Temperature	T_{ch}	150	˚C
Storage Temperature	T_{stg}	–55 to +150	˚C
Single Avalanche Current**	I_{AS}	50	A
Single Avalanche Energy**	E_{AS}	250	mJ

* PW ≤ 10 μs, Duty Cycle ≤ 1 %

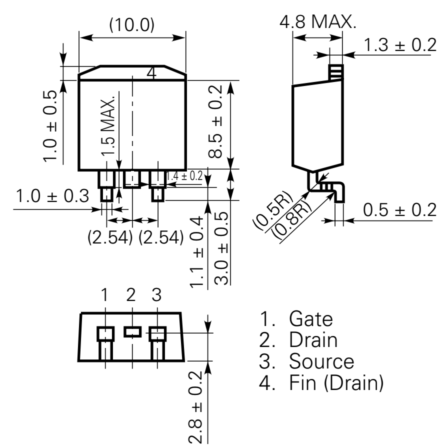
** Starting T_{ch} = 25 ˚C, R_G = 25 Ω, V_{GS} = 20 V → 0

PACKAGE DIMENSIONS

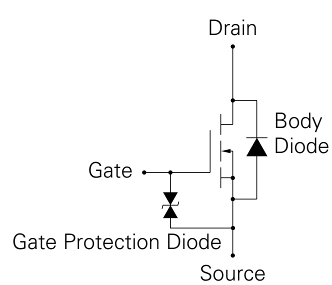
(in millimeters)



MP-25 (TO-220)



MP-25Z (SURFACE MOUNT TYPE)

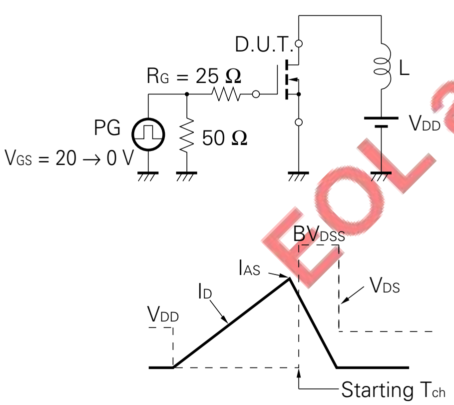


Document No. D10045EJ1V0DS00 (1st edition)
Date Published May 1995 P
Printed in Japan

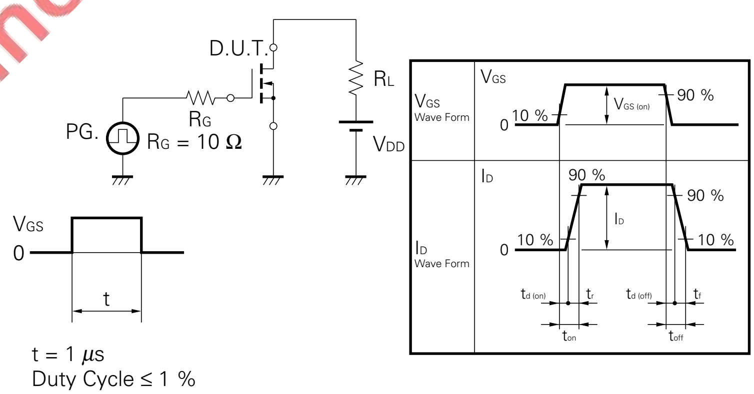
ELECTRICAL CHARACTERISTICS (T_A = 25 °C)

CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITIONS
Drain to Source On-State Resistance	$R_{DS(on)1}$		7.3	9.0	mΩ	V_{GS} = 10 V, I_D = 25 A
	$R_{DS(on)2}$		11	14	mΩ	V_{GS} = 4 V, I_D = 25 A
Gate to Source Cutoff Voltage	$V_{GS(off)}$	1.0	1.5	2.0	V	V_{DS} = 10 V, I_D = 1 mA
Forward Transfer Admittance	$\lvert y_{fs} \rvert$	20	58		S	V_{DS} = 10 V, I_D = 25 A
Drain Leakage Current	I_{DSS}			10	μA	V_{DS} = 60 V, V_{GS} = 0
Gate to Source Leakage Current	I_{GSS}			±10	μA	V_{GS} = ±20 V, V_{DS} = 0
Input Capacitance	C_{iss}		3 400		pF	V_{DS} = 10 V
Output Capacitance	C_{oss}		1 600		pF	V_{GS} = 0
Reverse Transfer Capacitance	C_{rss}		770		pF	f = 1 MHz
Turn-On Delay Time	$t_{d(on)}$		55		ns	I_D = 25 A
Rise Time	t_r		360		ns	$V_{GS(on)}$ = 10 V
Turn-Off Delay Time	$t_{d(off)}$		480		ns	V_{DD} = 30 V
Fall Time	t_f		360		ns	R_G = 10 Ω
Total Gate Charge	Q_G		152		nC	I_D = 50 A
Gate to Source Charge	Q_{GS}		11		nC	V_{DD} = 48 V
Gate to Drain Charge	Q_{GD}		60		nC	V_{GS} = 10 V
Body Diode Forward Voltage	$V_{F(S-D)}$		0.92		V	I_F = 50 A, V_{GS} = 0
Reverse Recovery Time	t_{rr}		105		ns	I_F = 50 A, V_{GS} = 0
Reverse Recovery Charge	Q_{rr}		265		nC	di/dt = 100 A/μs

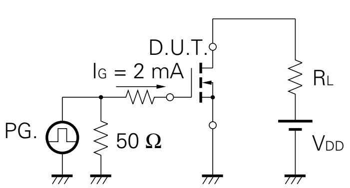
Test Circuit 1 Avalanche Capability



Test Circuit 2 Switching Time



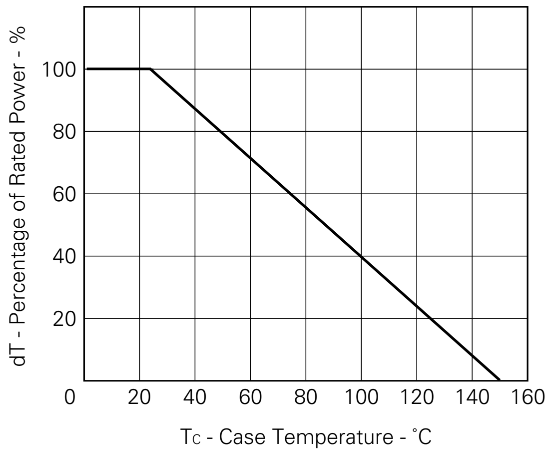
Test Circuit 3 Gate Charge



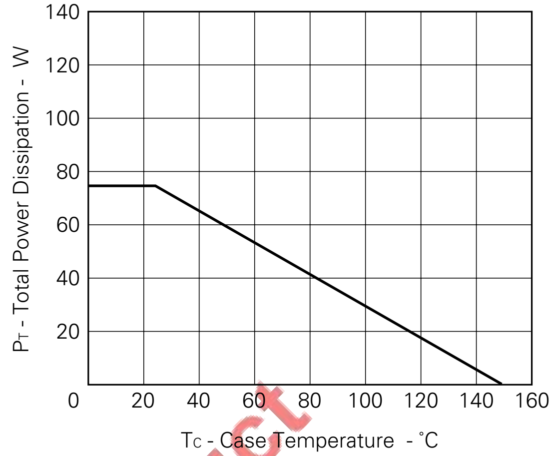
The application circuits and their parameters are for references only and are not intended for use in actual design-in's.

TYPICAL CHARACTERISTICS (T_A = 25 °C)

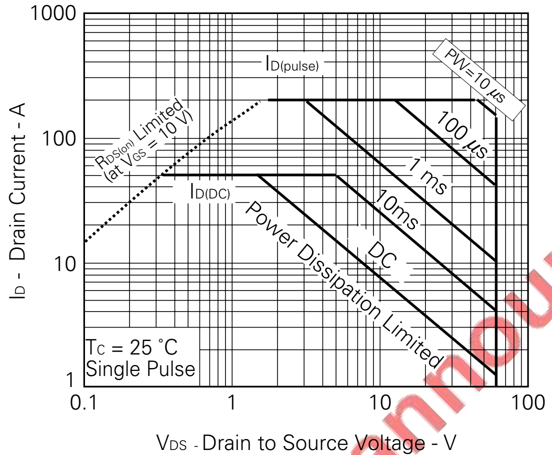
DERATING FACTOR OF FORWARD BIAS SAFE OPERATING AREA



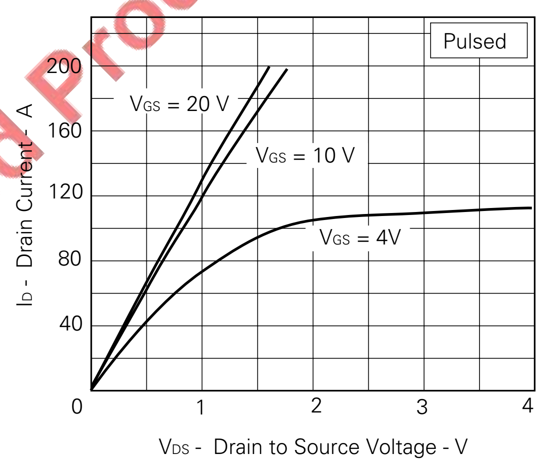
TOTAL POWER DISSIPATION vs. CASE TEMPERATURE



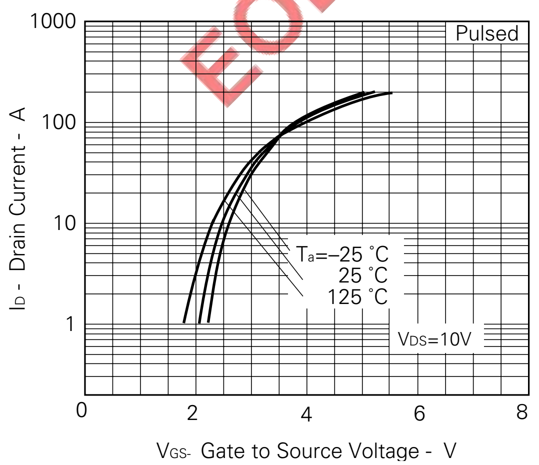
FORWARD BIAS SAFE OPERATING AREA



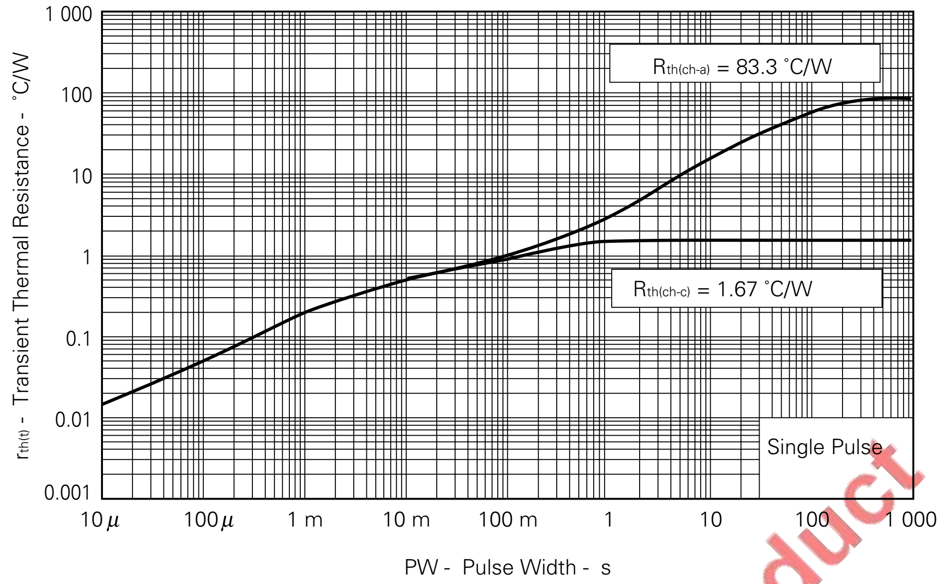
DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE



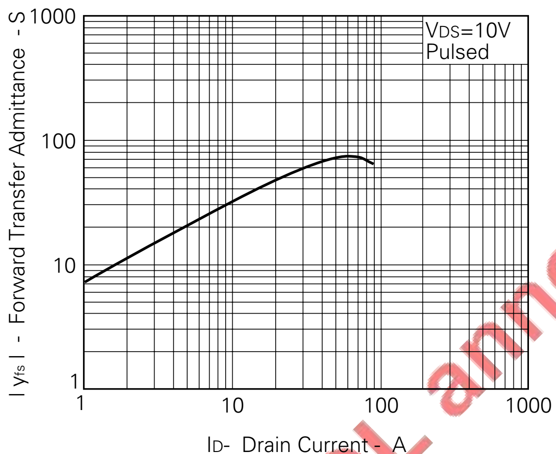
FORWARD TRANSFER CHARACTERISTICS



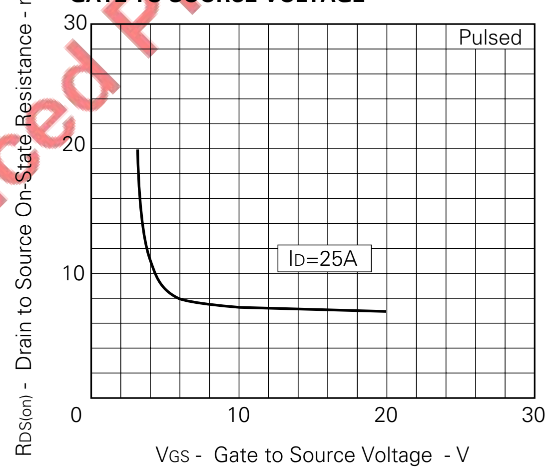
TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH



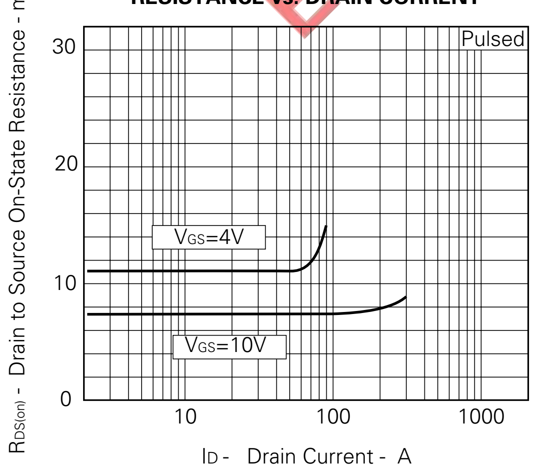
FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



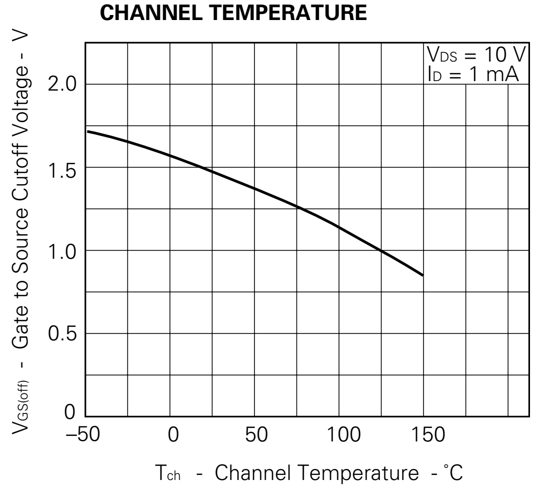
DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE



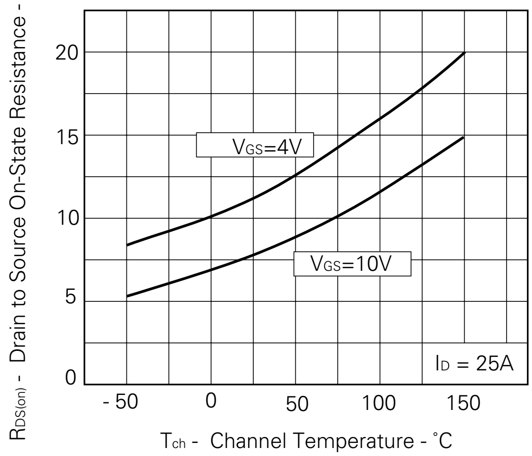
DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT



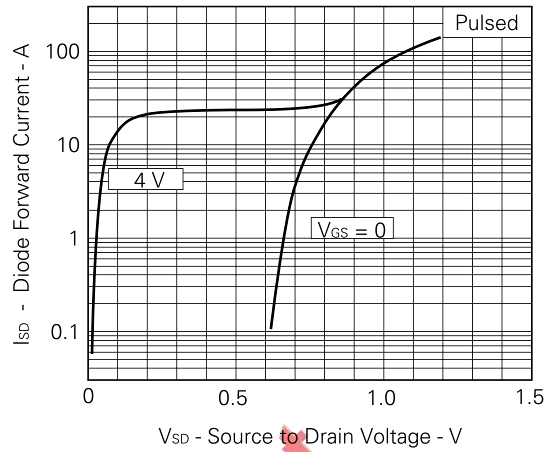
GATE TO SOURCE CUTOFF VOLTAGE vs. CHANNEL TEMPERATURE



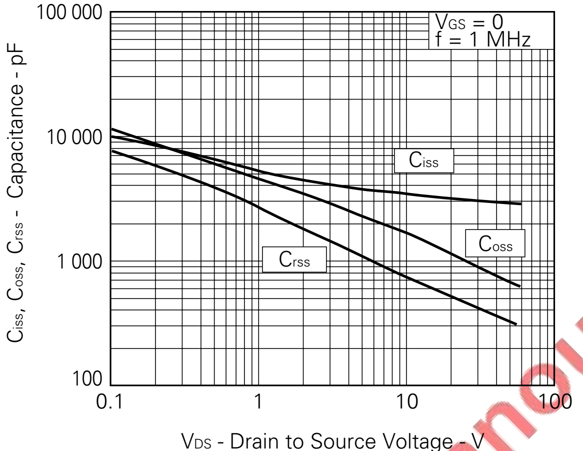
DRAIN TO SOURCE ON-STATE RESISTANCE vs. CHANNEL TEMPERATURE



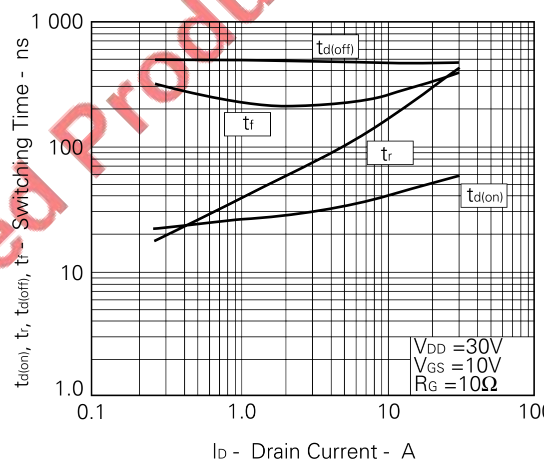
SOURCE TO DRAIN DIODE FORWARD VOLTAGE



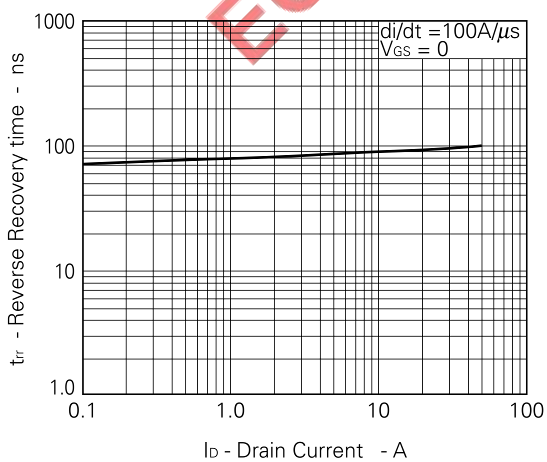
CAPACITANCE vs. DRAIN TO SOURCE VOLTAGE



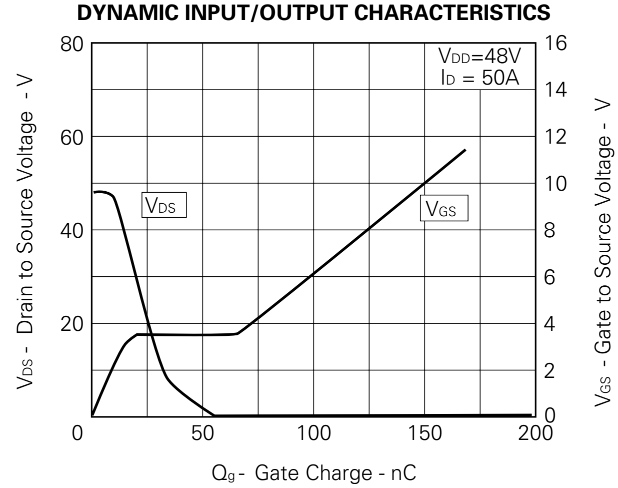
SWITCHING CHARACTERISTICS



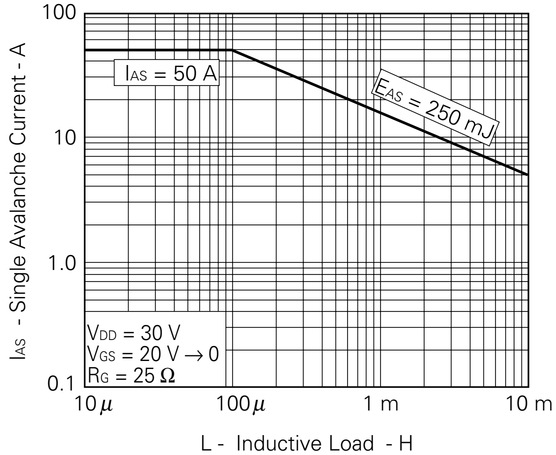
REVERSE RECOVERY TIME vs. DRAIN CURRENT



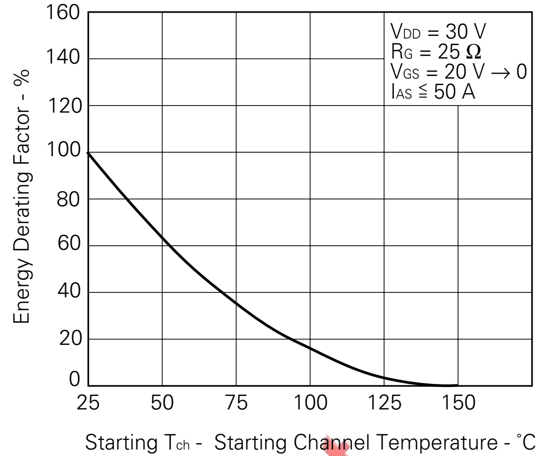
DYNAMIC INPUT/OUTPUT CHARACTERISTICS



SINGLE AVALANCHE CURRENT vs. INDUCTIVE LOAD



SINGLE AVALANCHE ENERGY DERATING FACTOR



REFERENCE

Document Name	Document No.
NEC semiconductor device reliability/quality control system.	TEI-1202
Quality grade on NEC semiconductor devices.	IEI-1209
Semiconductor device mounting technology manual.	IEI-1207
Semiconductor device package manual.	IEI-1213
Guide to quality assurance for semiconductor devices.	MEI-1202
Semiconductor selection guide.	MF-1134
Power MOS FET features and application switching power supply.	TEA-1034
Application circuits using Power MOS FET.	TEA-1035
Safe operating area of Power MOS FET.	TEA-1037

The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device is actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

[MEMO]